

Technical Data :

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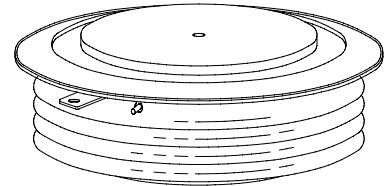
R3968FC28M

- Power Thyristor
2800 V_{DRM};

HIGH POWER THYRISTOR FOR INVERTER APPLICATIONS

Features:

- . All Diffused Structure
- . Involute Amplifying Gate Configuration
- . Blocking capability up to 2800 volts
- . Guaranteed Maximum Turn-Off Time
- . High dV/dt Capability
- . Pressure Assembled Device



ELECTRICAL CHARACTERISTICS AND RATINGS

Blocking - Off State

Device Type	V _{RRM} (1)	V _{DRM} (1)	V _{RSM} (1)
R3968FC28M	2800	2800	2900

V_{RRM} = Repetitive peak reverse voltage

V_{DRM} = Repetitive peak off state voltage

V_{RSM} = Non repetitive peak reverse voltage (2)

Repetitive peak reverse leakage and off state leakage	I _{RRM} / I _{DRM}	200 mA (3)
Critical rate of voltage rise	dV/dt (4)	200 V/μsec

Conducting - on state

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Average value of on-state current	I _{T(AV)}		4001		A	Sinewave, 180° conduction, T _S =55°C
RMS value of on-state current	I _{TRMS}		7988		A	Nominal value
Peak one cPSTCle surge (non repetitive) current	I _{TSM}		66000		A	10.0 msec (50Hz), sinusoidal wave-shape, 180° conduction, T _j = 125 °C
I square t	I ² t		21.7x10 ⁶		A ² s	10.0 msec
Latching current	I _L		1000		mA	V _D = 24 V; R _L = 12 ohms
Holding current	I _H		500		mA	V _D = 24 V; I = 2.5 A
Peak on-state voltage	V _{TM}		2.45		V	I _{TM} = 6000 A; T _j = 125 °C
Critical rate of rise of on-state current (5, 6)	di/dt		1000		A/μs	Switching from V _{DRM} ≤ 1000 V, non-repetitive
Critical rate of rise of on-state current (6)	di/dt		500		A/μs	Switching from V _{DRM} ≤ 1000 V

Notes:

All ratings are specified for T_j=25 °C unless otherwise stated.

(1) All voltage ratings are specified for an applied 50Hz/60Hz sinusoidal waveform over the temperature range -40 to +125 °C.

(2) 10 msec. max. pulse width

(3) Maximum value for T_j = 125 °C.

(4) Minimum value for linear and exponential waveshape to 80% rated V_{DRM}. Gate open. T_j = 125 °C.

(5) Non-repetitive value.

(6) The value of di/dt is established in accordance with EIA/NIMA Standard RS-397, Section 5-2-2-6. The value defined would be in addition to that obtained from a snubber circuit, comprising a 0.2 μF capacitor and 20 ohms resistance in parallel with the thristor under test.

ELECTRICAL CHARACTERISTICS AND RATINGS
Thyristor
R3968FC28M- Power
Gating

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Peak gate power dissipation	P _{GM}		200		W	t _p = 40 us
Average gate power dissipation	P _{G(AV)}		5		W	
Peak gate current	I _{GM}		20		A	
Gate current required to trigger all units	I _{GT}		300 200 125		mA	V _D = 6 V; R _L = 3 ohms; T _j = -40 °C V _D = 6 V; R _L = 3 ohms; T _j = +25 °C V _D = 6 V; R _L = 3 ohms; T _j = +125 °C
Gate voltage required to trigger all units	V _{GT}	0.30	5 4		V	V _D = 6 V; R _L = 3 ohms; T _j = -40 °C V _D = 6 V; R _L = 3 ohms; T _j = 0-125 °C V _D = Rated V _{DRM} ; R _L = 1000 ohms; T _j = + 125 °C
Peak negative voltage	V _{GRM}		20		V	

Dynamic

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Delay time	t _d	0.8	2.0		μs	I _{TM} = 4000 A; V _D = 67% V _{DRM} Gate pulse: V _G = 30 V; R _G = 10 ohms; t _r = 0.1 μs; t _b = 20 μs
Turn-off time	t _q	50	100	70	μs	I _{TM} = 4000 A; di/dt = 60 A/μs; V _R ≥ 100 V; Re-applied dV/dt = 20 V/μs linear to 67% V _{DRM} ; T _j = 125 °C; Duty cPSTCle ≥ 0.01%
Reverse recovery current	I _{rr}				A	I _{TM} = 4000 A; di/dt = 60 A/μs; V _R ≥ -50 V; T _j = 125 °C

THERMAL AND MECHANICAL CHARACTERISTICS AND RATINGS

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Operating temperature	T _j	-40	+125		°C	
Storage temperature	T _{stg}	-40	+150		°C	
Thermal resistance - junction to sink	R _{θ(j-S)}		0.0065		°C/W	Double sided cooled
Mounting force	P	81	99		kN	
Weight	W		2.7		Kg.	

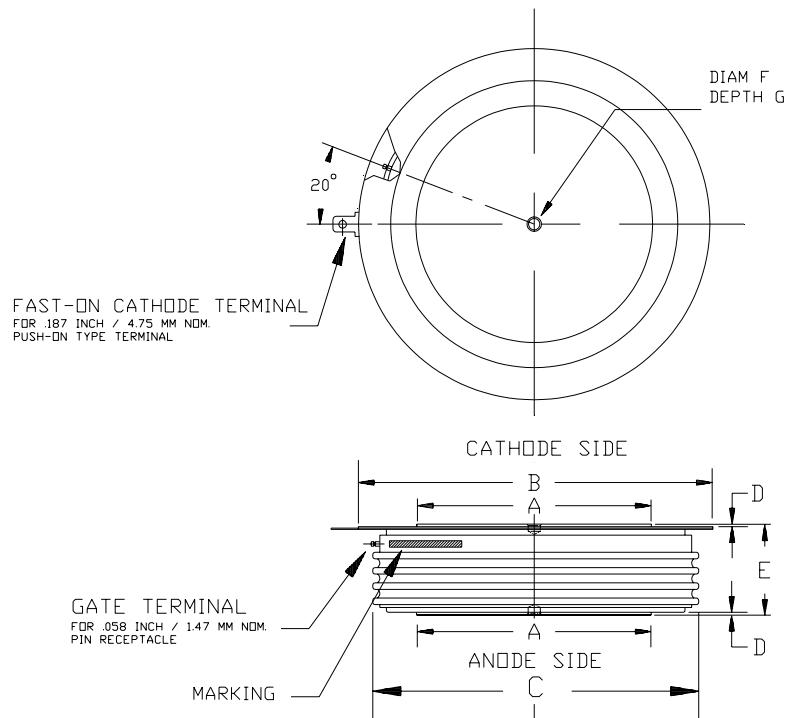
* Mounting surfaces smooth, flat and greased

Note : for case outline and dimensions, see case outline drawing in page 3 of this Technical Data

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R3968FC28M - Power Thyristor CASE OUTLINE AND DIMENSIONS.



Sym	A	B	C	E
Inches	3.93	5.90	5.15	1.37
mm	100	150	131	35±1.0